

Application No. 10/713,606
Confirmation No. 2509
Art Unit 1752, Examiner Walke
Docket No. CL-2229 US NA
September 14, 2007
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Remarks: General

The claims have been amended by rewriting Claims 25 and 34 for the purpose of presenting therein a more detailed description of certain features of particular interest that are included among the various embodiments of this invention. Other claims that are dependent thereon, respectively, have also been amended to provide for compatibility of phrasing in the claims.

No new matter is added by these amendments.

As Claims 1~24 have previously been cancelled, Claims 25~44 remain active in the application

By Applicant's calculation, no fee is due by reason of this amendment to the claims. If, however, any fee is required to authorize or obtain consideration of this response, please charge such fee to Deposit Account No. 04-1928.

Applicant hereby requests reconsideration and further examination of the application in view of the reasons it has set forth below for allowance of the claims.

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Remarks: Detailed Action

In Item 2, the Examiner has rejected Claims 25~44 under 35 U.S.C. §103(a) as being unpatentable over US 6,107,360 ("Kaneko").

Remarks previously made are incorporated herein by reference.

All that the portions of Applicant's specification cited by the Examiner state is that it has been known to use protective layers. It is clear from that discussion that the types of compositions previously used to prepare protective layers could be attacked by the solvents typically used in thick film paste compositions, and that the types of compositions described in Applicant's specification solve that problem. Applicant's specification does not state or imply that the types of compositions described therein for use in a protective layer have been previously known for use for such purpose.

It is submitted that Kaneko does not teach or suggest use of the type of protective layer composition to which the pending claims are directed because Kaneko requires in its protective composition the presence of solar radiation absorbable fine particles of an inorganic metal. As Applicant's claims are now directed to the use of a photopolymerizable composition that consists essentially of a polymer as described therein, the presence of such metal particles is excluded therefrom. Nothing in Kaneko suggests using the protective composition thereof without the metal particles since omitting the metal particles would defeat the stated purpose of providing a solar radiation blocking composition.

In addition, Kaneko does not teach or suggest the use of a mask or a developing step as required by the pending claims. This indicates, as noted previously, that nothing about Kaneko suggests that the protective composition disclosed therein be used in relation to a process where photopatterning or photoimaging is involved.

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In view of the above distinctions between Kaneko and the subject matter of Claims 25~44, Applicant respectfully requests that the Examiner withdraw the rejection of those claims under 35 U.S.C. §103(a).

In view of the foregoing, Applicant requests entry of the above described amendments; and submits that all of the Examiner's objections and rejections have been properly traversed, and that the pending claims are in condition for allowance, request for which is hereby respectfully made.

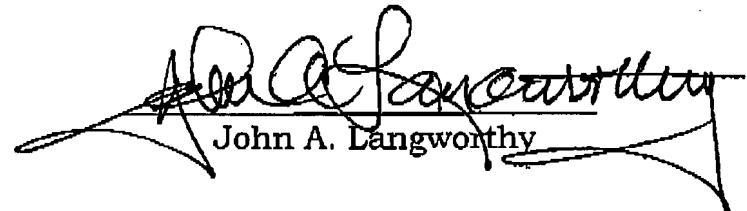
Respectfully submitted,



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I hereby certify that this correspondence is being facsimile transmitted to the U.S. Patent and Trademark Office on September 14, 2007.

Date: September 14, 2007



John A. Langworthy